Quad. Analog Switches / Quad. Multiplexers

HITACHI

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Description

The HD74LV4066A handles both analog and digital signals, and enables signals of either type with amplitudes of up to 5.5 V (peak) to be transmitted in either direction (at $V_{CC} = 0$ V to 5.5 V). Each switch section has its own enable input control (C). A high-level voltage applied to C turns on the associated switch section.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

Features

- $V_{CC} = 2.0 \text{ V}$ to 5.5 V operation
- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V)

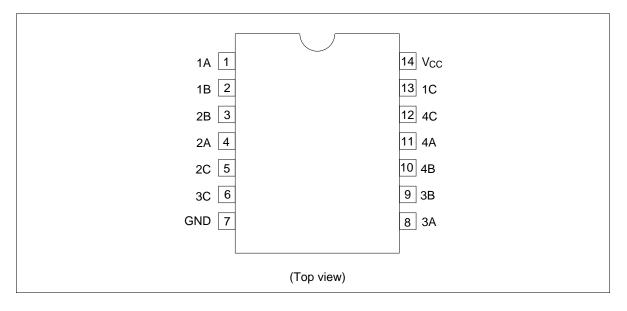
Function Table

Control	Switch
L	OFF
Н	ON
Note: H: High level	

L: Low level



Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{cc}	-0.5 to 7.0	V	
Input voltage range*1	V	-0.5 to 7.0	V	
Output voltage range*1,2	Vo	-0.5 to V _{cc} + 0.5	V	Output: H or L
Input clamp current	I _{IK}	-20	mA	V ₁ < 0
Output clamp current	Ι _{οκ}	±50	mA	V_{o} < 0 or V_{o} > V_{cc}
Continuous output current	I _o	±25	mA	$V_{o} = 0$ to V_{cc}
Continuous current through V_{cc} or GND	$I_{\rm CC}$ or $I_{\rm GND}$	±50	mA	
Maximum power dissipation at Ta = 25° C (in still air) ^{*3}	P _T	785	mW	SOP
		500	-	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time..

- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

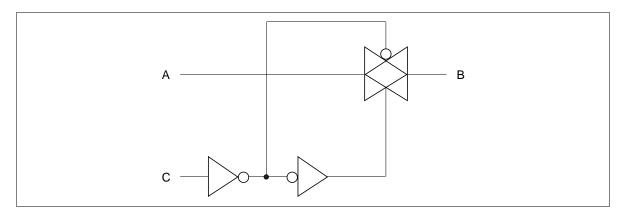
Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{cc}	2.0*1	5.5	V	
Input voltage range	V	0	5.5	V	
Output voltage range	V _{I/O}	0	V _{cc}	V	
Input transition rise or fall rate	$\Delta t/\Delta v$	0	200	ns/V	V_{cc} = 2.3 to 2.7 V
		0	100		V_{cc} = 3.0 to 3.6 V
		0	20		V_{cc} = 4.5 to 5.5 V
Operating free-air temperature	Та	-40	85	°C	

Notes: Unused or floating inputs must be held high or low.

 With the supply voltage at or around 2 V, the analog switch on-state resistance loses linearity significantly. It is recommended that only digital signals be transmitted at these low supply voltages.

Logic Diagram



DC Electrical Characteristics

			Ta = 25°C			Ta = –40 t	o 85°C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Input voltage	V _{IH}	2.0	—	—	_	1.5	_	V	
		2.3 to 2.7	_	_	_	$V_{CC} imes 0.7$	_	=	
		3.0 to 3.6	_	_	_	$V_{CC} imes 0.7$	_	=	
		4.5 to 5.5	_	_	_	$V_{CC} imes 0.7$	_	=	
	V _{IL}	2.0	_	_	_	_	0.5	-	
		2.3 to 2.7	_	_	_	_	$V_{CC} imes 0.3$	-	
		3.0 to 3.6	_	_	_	_	$V_{CC} imes 0.3$	-	
		4.5 to 5.5	_	_	_	_	$V_{CC} imes 0.3$	-	
On-state switch resistance	R _{on}	2.3	_	60	180	_	225	Ω	$V_{IN} = V_{CC} \text{ or GND}$ $V_{C} = V_{IH}$ $I_{T} = 1 \text{ mA}$
		3.0	_	50	150		190	=	
		4.5	_	40	75	_	100	-	
Peak on resistance	R _{on (P)}	2.3	_	250	500	_	600	Ω	$V_{IN} = V_{CC}$ to GND $V_{C} = V_{IH}$ $I_{T} = 1 \text{ mA}$
		3.0	—	100	180	_	225	-	
		4.5	_	50	100		125	-	
Difference of on-state resistance between switches	ΔR _{on}	2.3	_	20	30	_	40	Ω	$V_{IN} = V_{CC}$ to GND $V_C = V_{IH}$ $I_T = 1 \text{ mA}$
		3.0	_	10	20	_	30	=	
		4.5	_	7	15	_	20	-	
Off-state switch leakage current	ls (OFF)	5.5	—	_	±0.1	_	±1.0	μΑ	$V_{\rm IN} = V_{\rm CC}, V_{\rm OUT} =$ GND or V_{\rm IN} = GND, $V_{\rm O} = V_{\rm CC}, V_{\rm C} = V_{\rm IL}$
On-state switch leakage current	ls (ON)	5.5	—	_	±0.1	_	±1.0	μΑ	$V_{IN} = V_{CC}$ or GND $V_{C} = V_{IH}$
Input current	I _{IN}	0 to 5.5	—	_	±0.1	_	±1.0	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent supply current	I _{cc}	5.5	—	—	_	_	20	μΑ	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max use the appropriate values under recommended operating conditions.

Switching Characteristics

• $V_{CC} = 2.5 \pm 0.2 V$

		Ta =	25°C		Ta = -	-40 to 85°C				
ltem	Symbol	Min	Тур	Мах	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	_	2.0	10.0	_	16.0	ns	C _L = 15 pF	A or B	B or A
		_	5.0	12.0	_	18.0		C _L = 50 pF		
Enable time	t _{zH} t _{ZL}	_	6.0	15.0	_	20.0	ns	$R_L = 1 k\Omega$ $C_L = 15 pF$	С	A or B
		_	8.0	25.0		32.0		C _L = 50 pF		
Disable time	t _{HZ} t _{LZ}	_	7.0	15.0		23.0	ns	$R_L = 1 k\Omega$ $C_L = 15 pF$	С	A or B
		_	11.0	25.0	_	32.0		C _L = 50 pF		

• $V_{CC} = 3.3 \pm 0.3 V$

		Ta =	25°C		Ta = -	-40 to 85°C	_				
ltem	Symbol	Min	Тур	Max	Min	Max	Unit	Test Condit	tions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	—	1.5	6.0		10.0	ns	$C_L = 15 \text{ pF}$		A or B	B or A
		—	4.0	9.0	—	12.0		$C_L = 50 \text{ pF}$			
Enable time	t _{zH} t _{zL}	—	4.0	11.0		15.0	ns	$R_L = 1 \ k\Omega$	C _L = 15 pF	С	A or B
		—	6.0	18.0	—	22.0			$C_L = 50 \text{ pF}$		
Disable time	t _{HZ} t _{LZ}	—	5.0	11.0		15.0	ns	$R_L = 1 \ k\Omega$	C _L = 15 pF	С	A or B
		_	8.0	18.0	_	22.0			$C_L = 50 \text{ pF}$		

Switching Characteristics (cont)

• $V_{CC} = 5.0 \pm 0.5 V$

		Ta =	25°C		Ta = –	40 to 85°C	_			
ltem	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	_	1.0	4.0	—	7.0	ns	C _L = 15 pF	A or B	B or A
		_	3.0	6.0	_	8.0		C _L = 50 pF		
Enable time	t _{zH} t _{ZL}	_	3.0	7.0	_	10.0	ns	$R_{L} = 1 k\Omega$ $C_{L} = 15 pF$	С	A or B
		_	5.0	12.0		16.0	-	C _L = 50 pF		
Disable time	t _{HZ} t _{LZ}	_	4.0	7.0	—	10.0	ns	$R_{L} = 1 k\Omega$ $C_{L} = 15 pF$	С	A or B
		—	6.0	12.0	_	16.0	-	C _L = 50 pF		

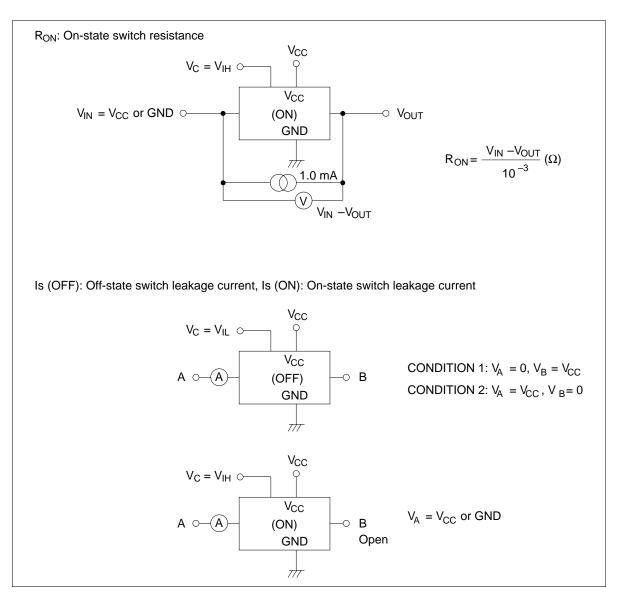
Switching Characteristics (cont)

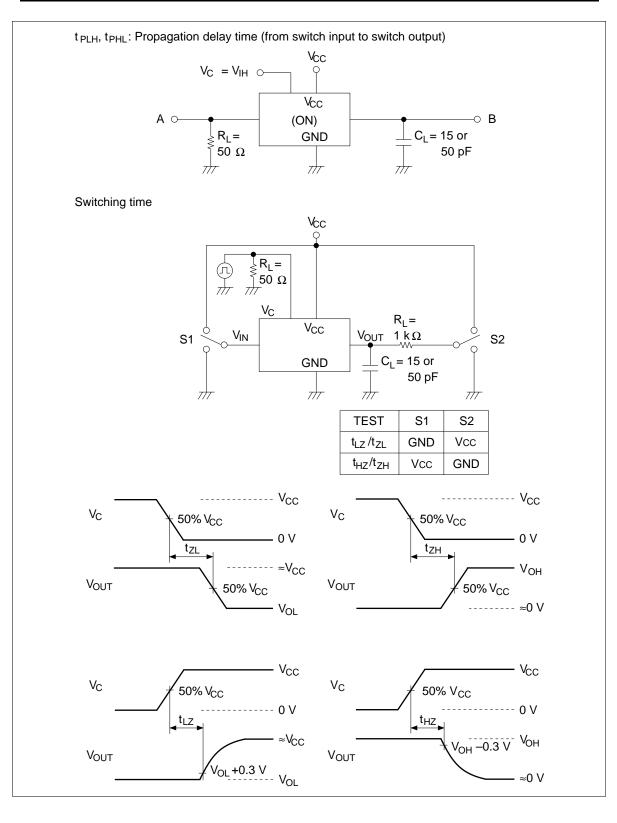
	Ta = 25°C								
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Control input capacitance	C _{IC}	_	_	3.5	_	pF			
Switch terminal capacitance	C _{I/O}	—	_	6.0	_	pF			
Feedthrough capacitance	C _T	—	—	0.5	—	pF			
Power dissipation capacitance	C _{PD}	—	—	4.0	—	pF			
Frequency response (Switch ON)		2.3	_	30.0	_	MHz	$\begin{array}{l} C_L = 50 \ \text{pF}, \ R_L = \\ 600 \ \Omega \\ \text{Adjust } f_{\text{in}} \ \text{voltage to} \\ \text{obtain } 0 \ \text{dBm at} \\ \text{output when } f_{\text{in}} \ \text{is 1} \\ \text{MHz} \ (\text{sine wave}). \\ \text{Increase } f_{\text{in}} \\ \text{frequency until the} \\ \text{dB-meter reads} \\ -3 \text{dBm}. \\ 20 \ \log (V_O/V_I) = -3 \\ \text{dBm} \end{array}$	A or B	B or A
		3.0	—	35.0	_	_			
		4.5	_	50.0	_	_			
Crosstalk (Between any switches)		2.3	_	-45.0		dB	$C_L = 50 \text{ pF}, R_L = 600 \Omega$ Adjust f _{in} voltage to obtain 0 dBm at input when f _{in} is 1 MHz (sine wave).	A or B	B or A
		3.0		-45.0	_	_			
		4.5	_	-45.0	_	_			
Crosstalk (Control input to signal output)		2.3	_	15.0	_	mV	$\begin{array}{l} C_{L}=50 \text{ pF}, \text{ R}_{L}=\\ 600 \ \Omega\\ \text{Adjust } \text{R}_{L} \text{ value to}\\ \text{obtain}\\ 0 \text{ A at } I_{\text{IN/OUT}} \text{ when}\\ f_{\text{in}} \text{ is}\\ 1 \text{ MHz} (\text{square}\\ \text{wave}). \end{array}$	С	A or B
		3.0	_	20.0	_	_			
		4.5	_	50.0	_				

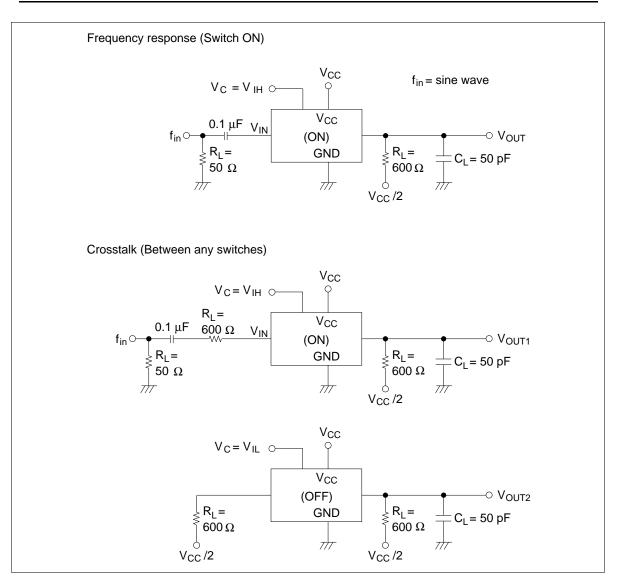
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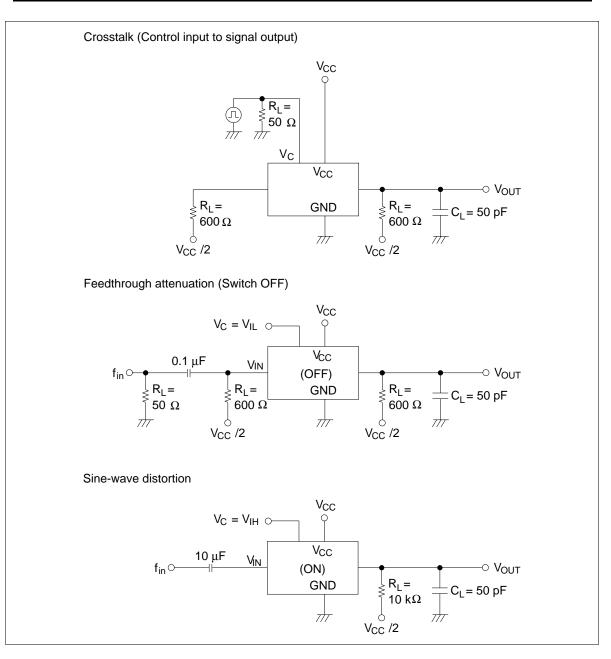
			Ta =	25°C					
ltem	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Feedthrough attenuation (Switch OFF)		2.3	_	-40.0	_	dB	$C_L = 50 \text{ pF}, R_L = 600 \Omega$ Adjust f_{in} voltage to obtain 0 dBm at input when f_{in} is 1 MHz (sine wave).	A or B	B or A
		3.0	_	-40.0	_	-			
		4.5	—	-40.0	_	-			
Sine-wave distortion		2.3	_	0.1	_	%	$\begin{array}{l} C_L = 50 \; pF, \; R_L = 10 \; k\Omega \\ f_{IN} = 1 \; kHz \; (sine \; wave) \\ V_I = 2 \; V_{P\!\cdot\!P}, \; V_{CC} = 2.3 \; V \\ V_I = 2.5 \; V_{P\!\cdot\!P}, \; V_{CC} = 3.0 \\ V \\ V_I = 4 \; V_{P\!\cdot\!P}, \; V_{CC} = 4.5 \; V \end{array}$	A or B	B or A
		3.0	_	0.1		-			
		4.5	_	0.1	_	-			

Test Circuits

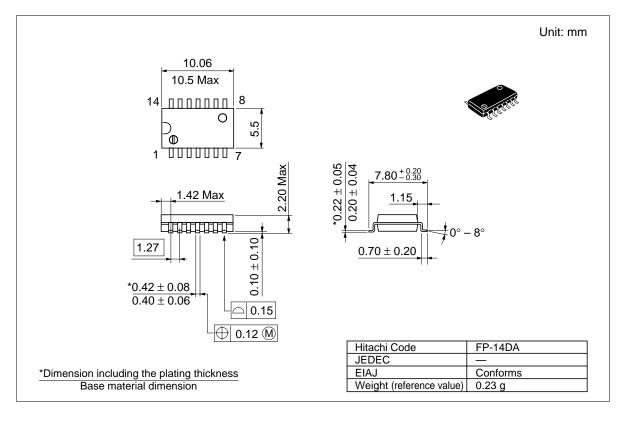


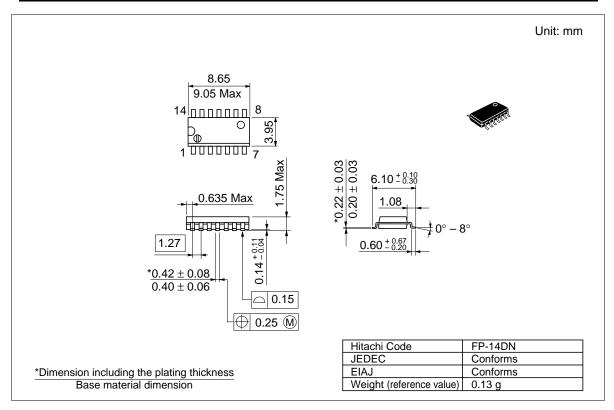


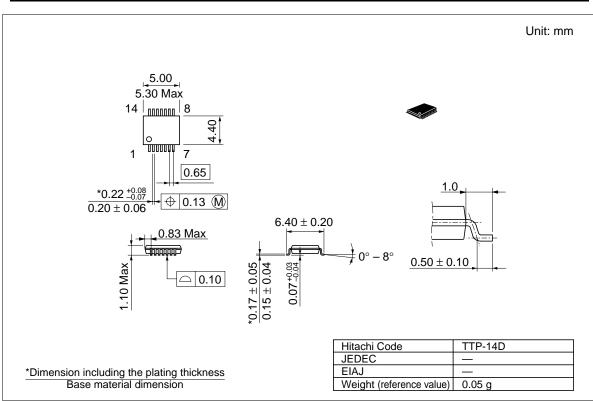




Package Dimensions







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